

https://www.phoenixcontact.com/us/products/1019724

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Complete housing for printed-circuit boards. Includes housing half shells, side panels with openings for all relevant connections, adhesive pads for affixing the Raspberry Pi model B2 and B3 computers, screws for housing and PCB attachment; light gray housing with turquoise-blue corner inlays

## Your advantages

- · High degree of application flexibility, thanks to the modular housing design
- · Flexible PCB attachment, adapts to virtually all form factors
- · Practical customization options
- · Reduced logistics outlay, thanks to components which are compatible with one another
- · Delivery as a complete housing with ready-machined side panels

## Commercial data

Item number	1019724
Packing unit	1 pc
Minimum order quantity	1 pc
Sales key	AC03
Product key	ACFCAA
GTIN	4055626507538
Weight per piece (including packing)	312.8 g
Weight per piece (excluding packing)	312.8 g
Customs tariff number	84879090
Country of origin	DE

1019724

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# Technical data

### Notes

General	The housing can be opened a maximum of 10 times.
General	Attach the adhesive pads: Make sure that the surface of the housing is clean, dry, and free of grease. Temperature range: +18°C +30°C / Closing pressure force: 60 N / Closing pressure time: 3 s

## Product properties

Product type	Complete housing
Housing series	UCS
Product family	UCS 125-87
Туре	Flat design (GD), RPI
Housing type	Universal housings
Ventilation openings present	no

### Dimensions

Dimensional drawing	h b b
Width	125 mm
Height	87 mm
Depth	47 mm
Dimensions	100 mm x 62 mm (Maximum circuit board dimensions)

### PCB design

PCB thickness	0.8 mm 3 mm

### Material specifications

Color (Housing)	light grey (RAL 7035)
Flammability rating according to UL 94	VO
CTI according to IEC 60112	225
Insulating material	PC
Surface characteristics	untreated
Housing material	PC

## Environmental and real-life conditions

Power dissipation single housing for 20 °C		
Ambient temperature	20 °C	
Reduction factor	1	
Mounting position	vertical	

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Power dissipation	9.7 W
	5.1 VV
Power dissipation single housing for 30 °C	
Ambient temperature	30 °C
Reduction factor	0.85
Mounting position	vertical
Power dissipation	8.3 W
Power dissipation single housing for 40 °C	
Ambient temperature	40 °C
Reduction factor	0.68
Mounting position	vertical
Power dissipation	6.5 W
Power dissipation single housing for 50 °C	
Ambient temperature	50 °C
Reduction factor	0.55
Mounting position	vertical
Power dissipation	5.4 W
Power dissipation single housing for 60 °C	
Ambient temperature	60 °C
Reduction factor	0.4
Mounting position	vertical
Power dissipation	3.9 W
Vibration test	
Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.15 mm (10 Hz 58.1 Hz)
Acceleration	2g (58.1 Hz 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis
Glow-wire test	
Specification	IEC 60695-2-11:2014-02
Temperature	850 °C
Time of exposure	30 s
Thermal stability / ball thrust test	
Thermal stability / ball thrust test Specification	
Temperature	IEC 60695-10-2:2014-02 125 °C
Test duration	125 C
Force	20 N
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Mechanical strength / tumbling barrel	
Specification	IEC 60068-2-31:2008-05



### 1019724

Height of fall

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Height of fail	50 cm
Frequency	50
Shocks	
Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	15g
Shock duration	11 ms
Number of shocks per direction	3
Test directions	X-, Y- and Z-axis (pos. and neg.)
Fest for substances that would hinder coating with paint or v	varnish
Specification	VW PV 3.10.7:2005-02
Result	Test passed
Degree of protection (IP code)	
Specification	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
Result, degree of protection, IP code	IP20
Ambient conditions	
Max. IP code to attain	IP20
Ambient temperature (operation)	-40 °C 105 °C (depending on power dissipation)
Ambient temperature (storage/transport)	-40 °C 55 °C
Ambient temperature (assembly)	-5 °C 100 °C
Relative humidity (storage/transport)	80 %
B data	
Number of PCB holders	1
Type of PCB mount	Bolt mounting
Total PCB surface	6000 mm <sup>2</sup>
Thickness of the PCB	0.8 mm 3 mm
Supported form factors	Raspberry Pi
Note on PCB holders	This product is prepared for a printed-circuit board. Additional printed-circuit boards can be mounted using adhesive pads (accessories).
ounting	
Mounting type	Screw mounting
Mounting position	any
Tightening torque / speed	Screw connection between housing halves: 1.2 Nm-1.4 Nm / 500 rpm-1000 rpm
	Mounting the PCB: 0.4 Nm-0.5 Nm / 500 rpm-1000 rpm
ckaging specifications	

50 cm

1019724

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## Classifications

### ECLASS

	ECLASS-11.0	27182702
	ECLASS-13.0	27190603
ETIM		
	ETIM 9.0	EC001031
UNSPSC		
	UNSPSC 21.0	31261500

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